Invitation for ASM-IIM Visiting Lectureship -2020

20th January 2020

A reciprocal 'ASM-IIM Visiting Lecture Program', enabling eminent Scientists, researchers, academicians from India and North America to deliver lectures in each calendar year in North America and India respectively, was approved in 2013 between The Indian Institute of Metals and ASM International.

On behalf of and the Indian Institute of Metals, we invite applications from eminent incumbents for the **ASM IIM Visiting lectureship 2020.**

The ASM-IIM Lectureship will be conferred on two different age groups (> 40 years & \leq 40 years of age, as on 1st January 2020.). As a selected lecturer, post delivering the lecture, on submission of relevant documents (duly certified by ASM) to substantiate the travel done, one shall be in receipt of an honorarium from IIM, for the amount of Rs. 50,000/- (Rupees Fifty thousand only) to partially support the candidate's travel cost incurred for travel to North America. IIM will provide selected candidates necessary support as per prevalent standards.

The last date of receiving applications is 15th March 2020. It is requested to email the duly filled application proforma with all requested credentials to the undersigned latest by the deadline specified.

Thanks & best regards

Kushal Saha

(Secretary General)

Encl: Application form



APPLICATION PROFORMA FOR IIM-ASM Visiting Lecture Program 2020

Soft copy of Application **in MSWord** to reach: The Secretary General, IIM, Kolkata at secretarygeneral.iim@gmail.com
latest by 15th March 2020

1. Name of the person	
2. Present Occupation & Designation	
3. Address for correspondence	
4. Date & Place of Birth	
5. Educational Qualifications	
(in chronological order)	
6. Professional Experience	
(in chronological order)	
7. List of Publications, Patents	
8. Membership of Professional Societies	
9. Professional Awards/Honors received	
10. Specific achievements in Metallurgy	
profession (max. 200 words)	
11. Visits planned in North America during	
the next financial year under the program	

Signature of the Applicant

*[Please enclose credentials as relevant]